Power MOSFET for 1-Cell Lithium-ion Battery Protection 12 V, 5.9 mΩ, 18 A, Dual N-Channel



ON Semiconductor®

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This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5 V drive
- 2 kV ESD HBM
- Common-Drain type
- ESD Diode-Protected Gate
- Pb-Free, Halogen Free and RoHS compliance

Typical Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Source to Source Voltage	VSSS	12	V
Gate to Source Voltage	VGSS	±12	V
Source Current (DC)	Is	18	Α
Source Current (Pulse) PW ≤ 10 μs, duty cycle ≤ 1%	ISP	60	Α
Total Dissipation (Note 2)	PT	2.0	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

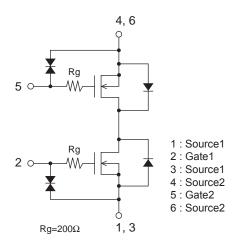
THERMAL RESISTANCE RATINGS

THERMAE REGIOTANCE RATINGS			
Parameter	Symbol	Value	Unit
Junction to Ambient (Note 2)	R _θ JA	62.5	°C/W

Note 2 : Surface mounted on ceramic substrate (5000 mm² × 0.8 mm).

Vsss	Rss(on) Max	IS Max
40.)/	5.9 mΩ @ 4.5 V	
	6.3 mΩ @ 4.0 V	18 A
12 V	6.5 mΩ @ 3.8 V	10 A
	8.2 mΩ @ 3.1 V	
	11 mΩ @ 2.5 V	

ELECTRICAL CONNECTION N-Channel



MARKING





ORDERING INFORMATION

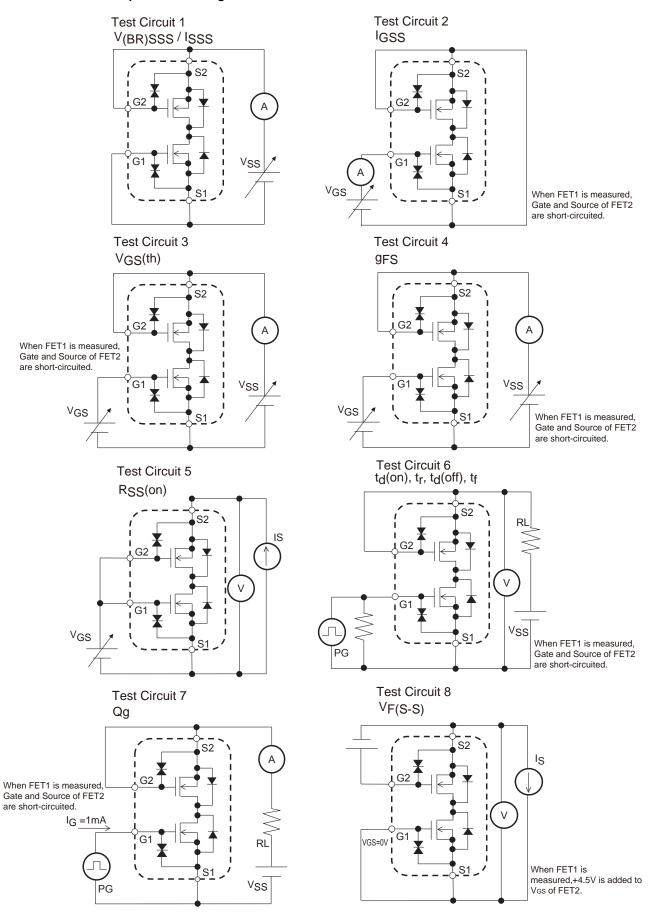
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS at $Ta = 25^{\circ}C$ (Note 3)

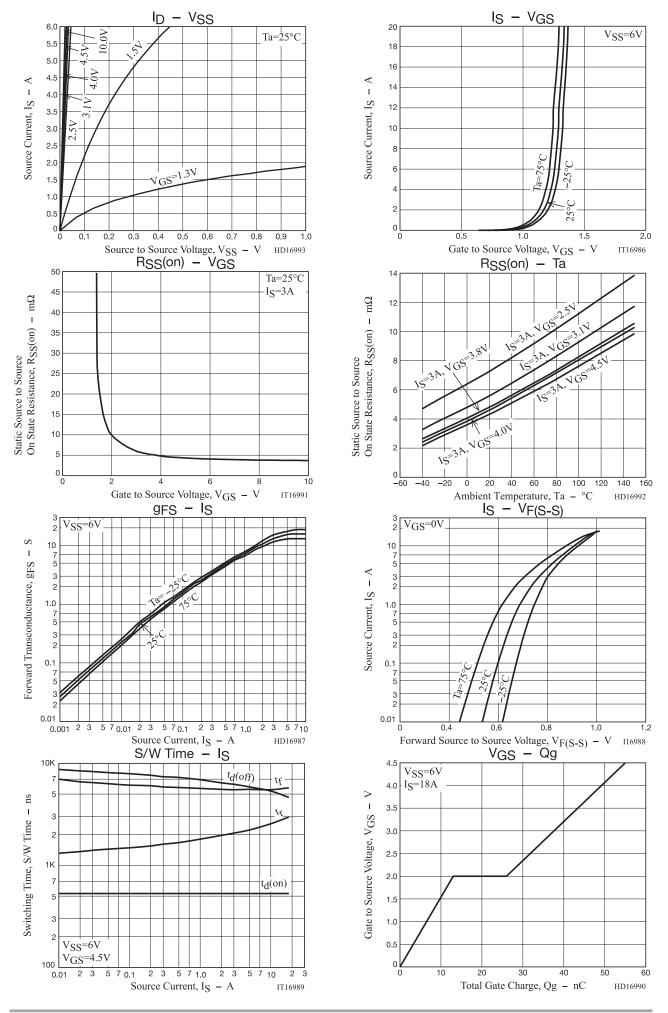
Damanatan	Outstand Outstand			Value			
Parameter	Symbol	Conditions		min	typ	max	Unit
Source to Source Breakdown Voltage	V(BR)SSS	IS = 1 mA, VGS = 0 V	Test Circuit 1	12			V
Zero-Gate Voltage Source Current	ISSS	V _{SS} = 10 V, V _{GS} = 0 V	Test Circuit 1			1	μА
Gate to Source Leakage Current	IGSS	V _{GS} = ±8 V, V _{SS} = 0 V	Test Circuit 2			±1	μА
Gate Threshold Voltage	V _{GS} (th)	V _{SS} = 6 V, I _S = 1 mA	Test Circuit 3	0.5		1.3	V
Forward Transconductance	gFS	V _{SS} = 6 V, I _S = 3 A	Test Circuit 4		13		S
Static Source to Source On-State Resistance	R _S S(on)	I _S = 3 A, V _{GS} = 4.5 V	Test Circuit 5	3.1	4.5	5.9	mΩ
		I _S = 3 A, V _{GS} = 4.0 V	Test Circuit 5	3.3	4.8	6.3	mΩ
		I _S = 3 A, V _{GS} = 3.8 V	Test Circuit 5	3.5	5.0	6.5	mΩ
		I _S = 3 A, V _{GS} = 3.1 V	Test Circuit 5	4.0	5.8	8.2	mΩ
		I _S = 3 A, V _{GS} = 2.5 V	Test Circuit 5	5.2	7.5	11	mΩ
Turn-ON Delay Time	t _d (on)				530		ns
Rise Time	t _r	V _{SS} = 6 V, V _G _S = 4.5 V			2,100		ns
Turn-OFF Delay Time	t _d (off)	IS = 3 A	Test Circuit 6		6,200		ns
Fall Time	tf				5,500		ns
Total Gate Charge	Qg	V _S S = 6 V, V _G S = 4.5 V I _S = 18 A	Test Circuit 7		55		nC
Forward Source to Source Voltage	VF(S-S)	I _S = 3 A, V _{GS} = 0 V	Test Circuit 8		0.76	1.2	V

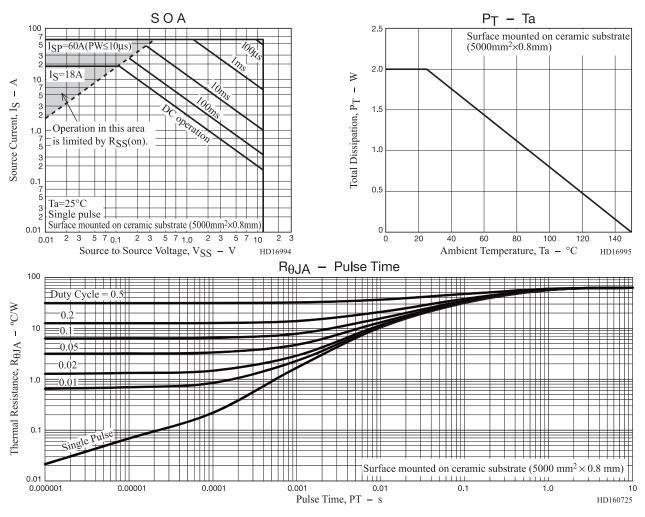
Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test circuits are example of measuring FET1 side



When FET2 is measured, the position of FET1 and FET2 is switched.



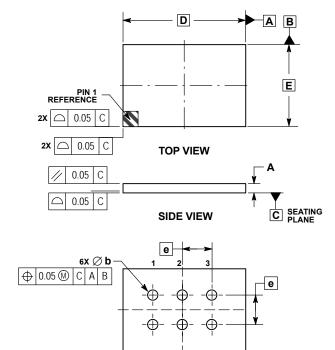


PACKAGE DIMENSIONS

unit: mm

WLCSP6 1.81x2.70 / EFCP2718-6CE-020

CASE 567HS **ISSUE A**



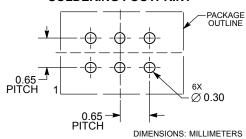
BOTTOM VIEW

NOTES

- DIMENSIONING AND TOLERANCING PER
 ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.18	0.22	
b	0.27	0.33	
D	2.70 BSC		
Е	1.81 BSC		
е	0.65 BSC		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

1: Source 1

2: Gate 1

3 · Source 1

4 : Source 2 5: Gate 2

6: Source 2

ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)
EFC6602R-TR	МВ	WLCSP6 1.81x2.70 / EFCP2718-6CE-020 (Pb-Free / Halogen Free)	5,000 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage: Since the EFC6602R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

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